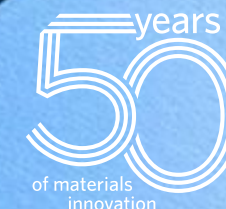


# Acceleration

Jay Kerley

Group VP & CIO, Applied Materials, Inc.

New Street Accelerated Computing Conference



## OUR VISION

Our innovations **make possible** the technology shaping the future

## OUR MISSION

To lead the world with **materials engineering** solutions that enable customers to transform possibilities into reality



Semiconductor Systems

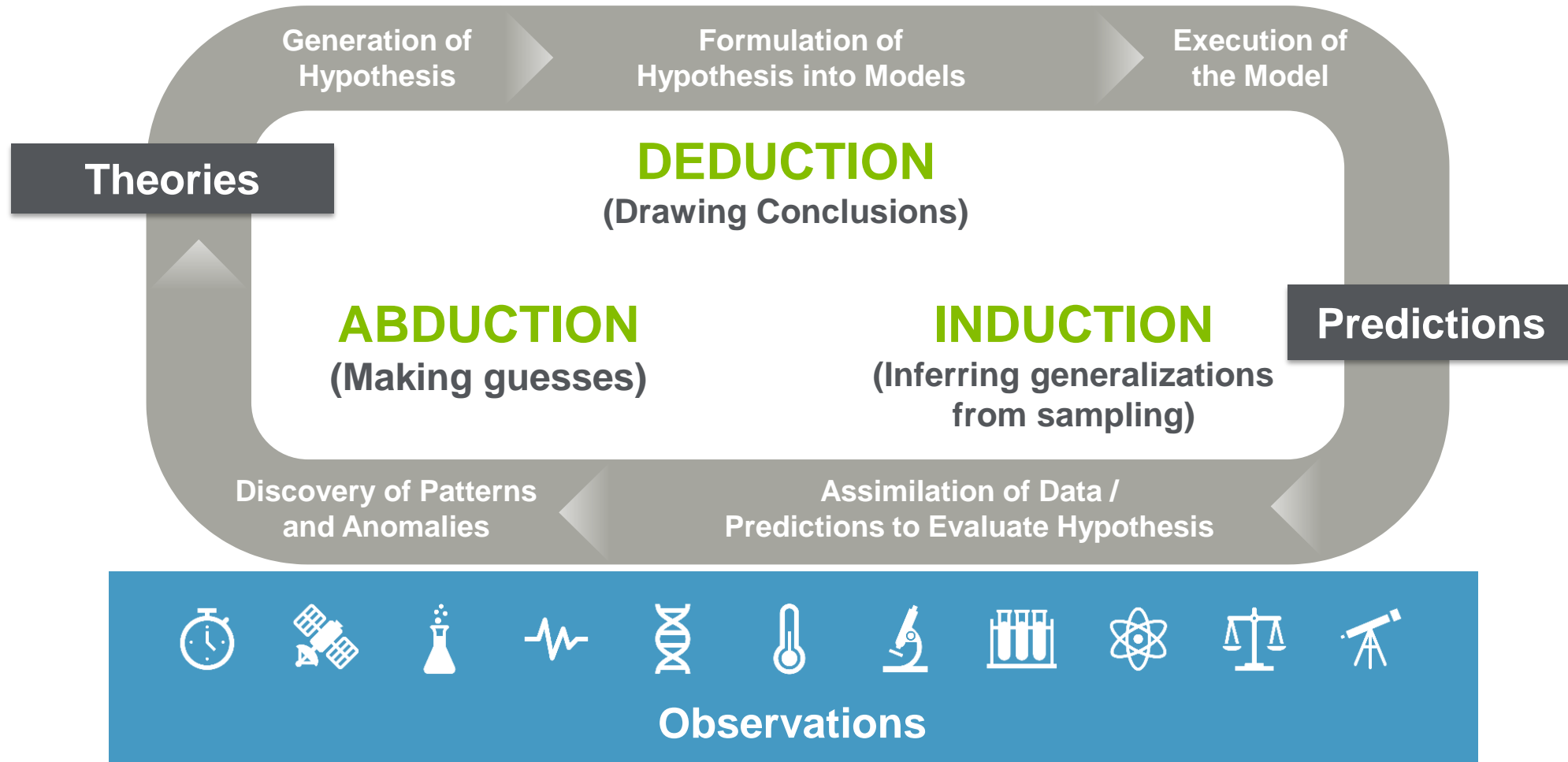


Applied Global Services

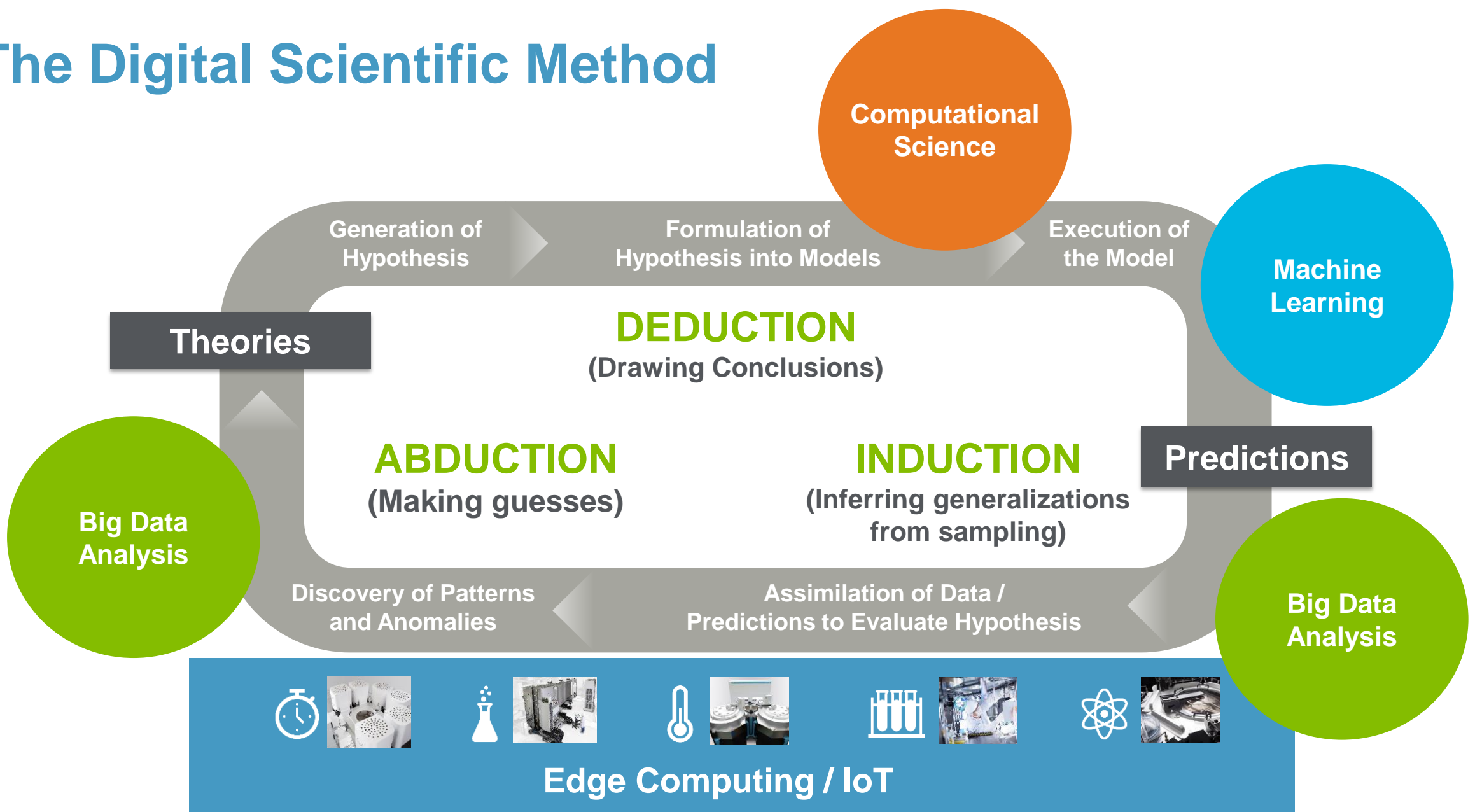


Display and Adjacent Markets

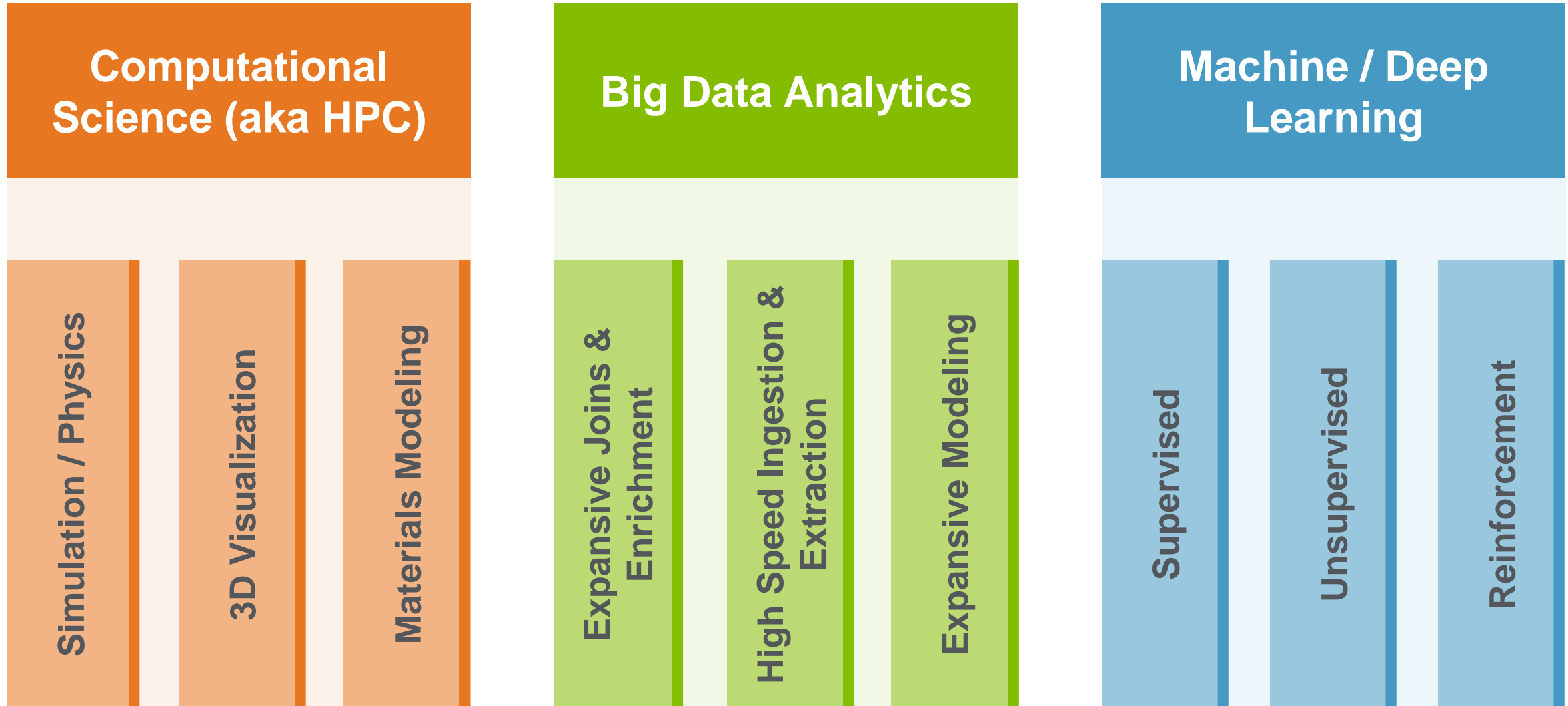
# The Scientific Method



# The Digital Scientific Method

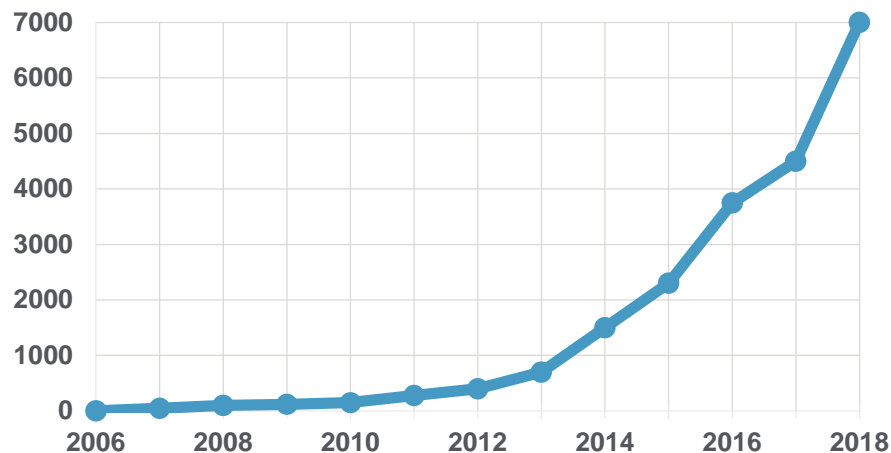


# It's All About – Acceleration



# Computational Science at Applied Materials

## HPC Total Cores



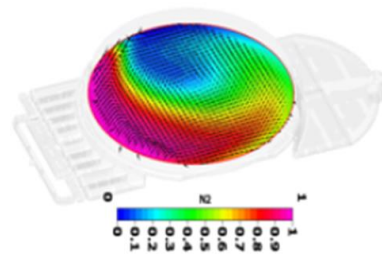
**4496**

Physical  
Cores

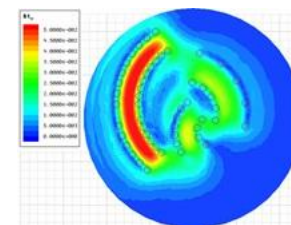


**25TB**

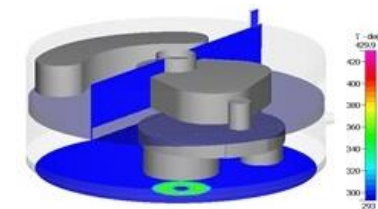
Memory



Flow/Chemistry



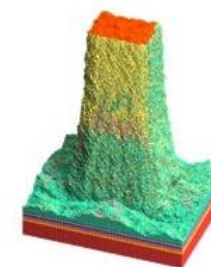
Magnetic Field



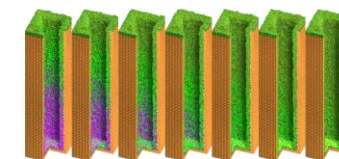
Thermal



Computational Chemistry



Surface engineering



Film profile growth

**Multi-scale, multi-physics modeling enabling hardware and process innovations at AMAT**



**SPEED**

Learning Rate and Time-to-Market

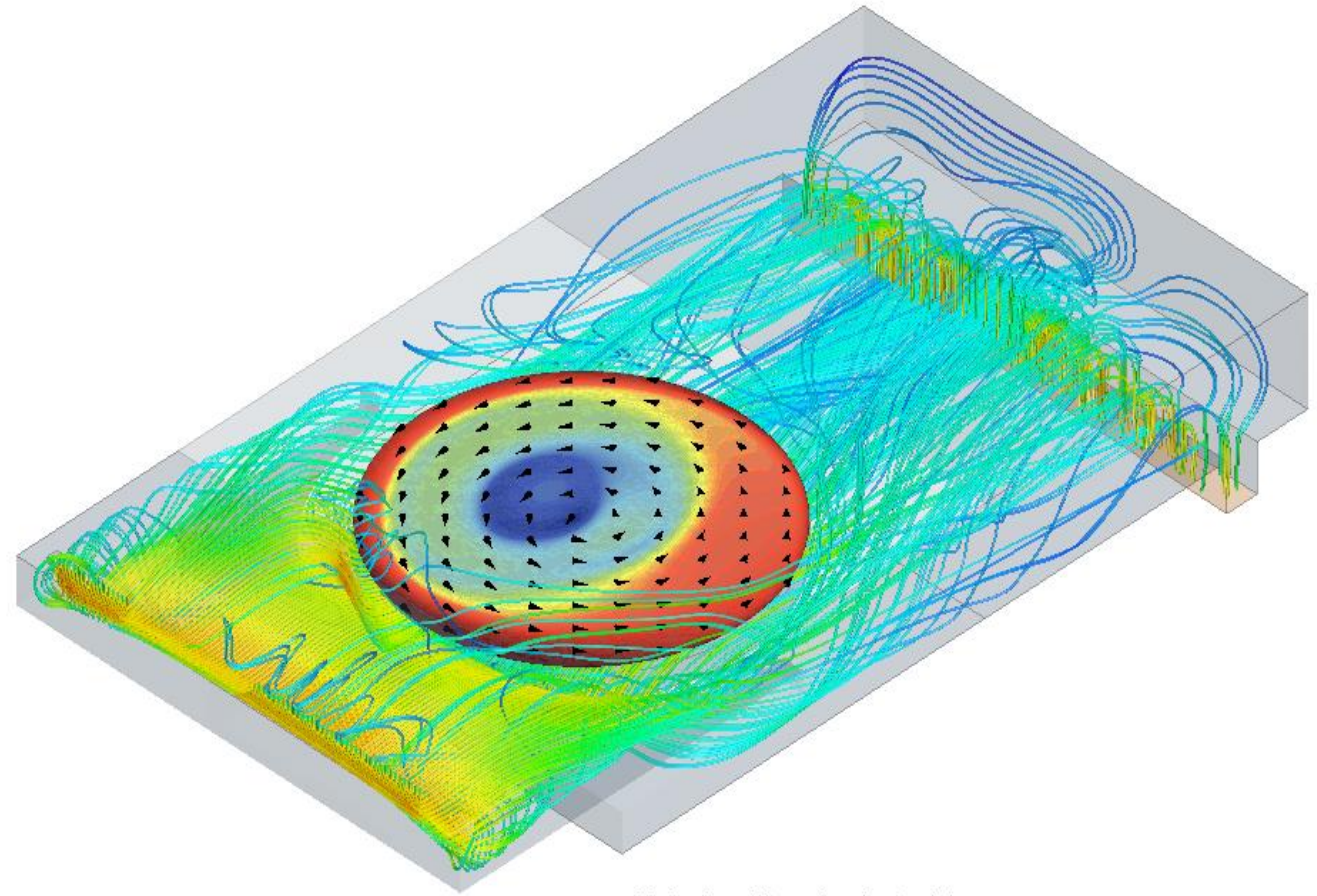
# 3D Visualization is Critical to Learning



$$R_1 = k_{\text{ad}}[\text{SiHCl}_3]$$

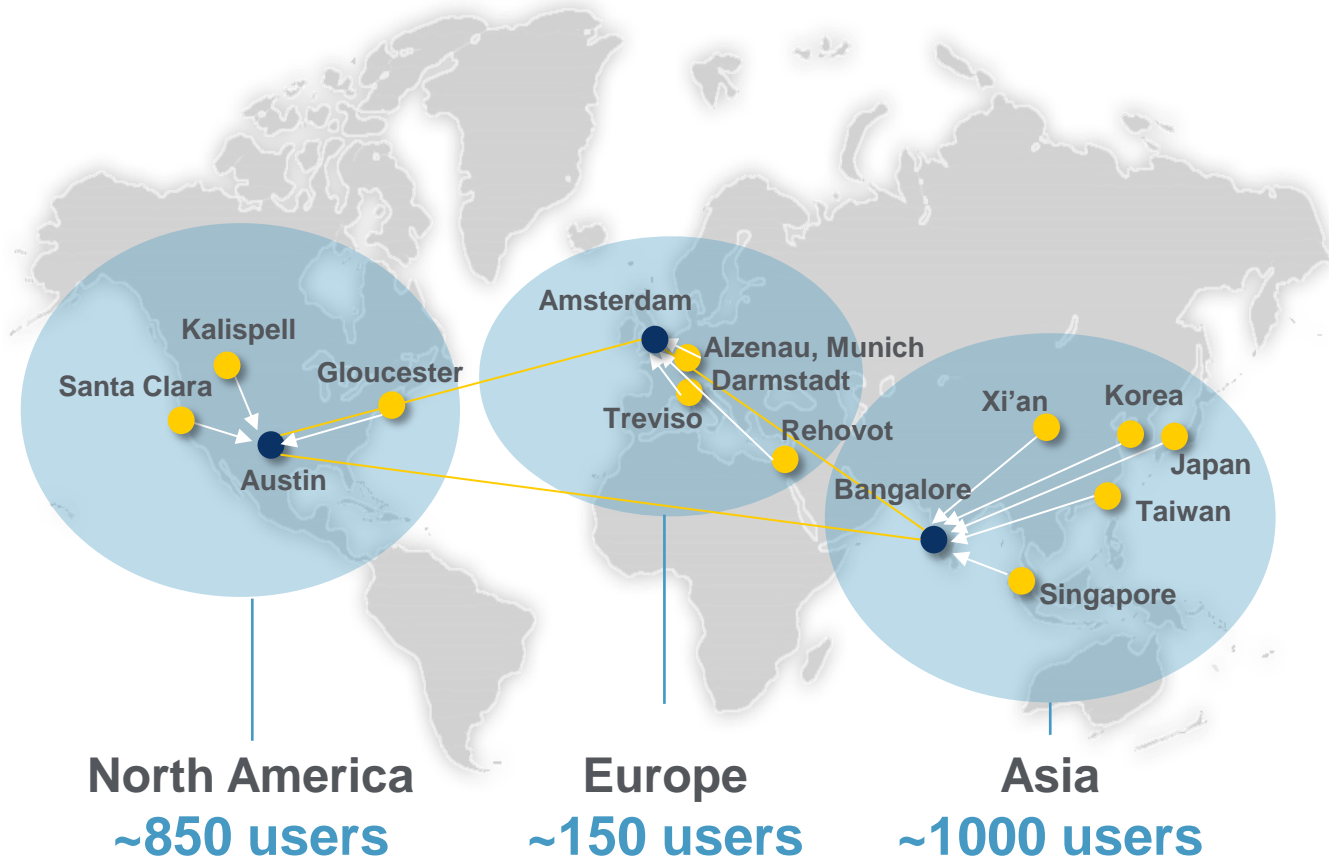
$$R_2 = k_r[\text{SiCl}_2][\text{H}_2]$$

$$k_i = A_i T^{\beta_i} e^{-E_{a,i} / RT}$$



Translation into Visual Models

# Global Design Backbone



**1.6M**  
CUDA Cores



**> 3300**  
sessions



**35,500**  
x86 HT Cores

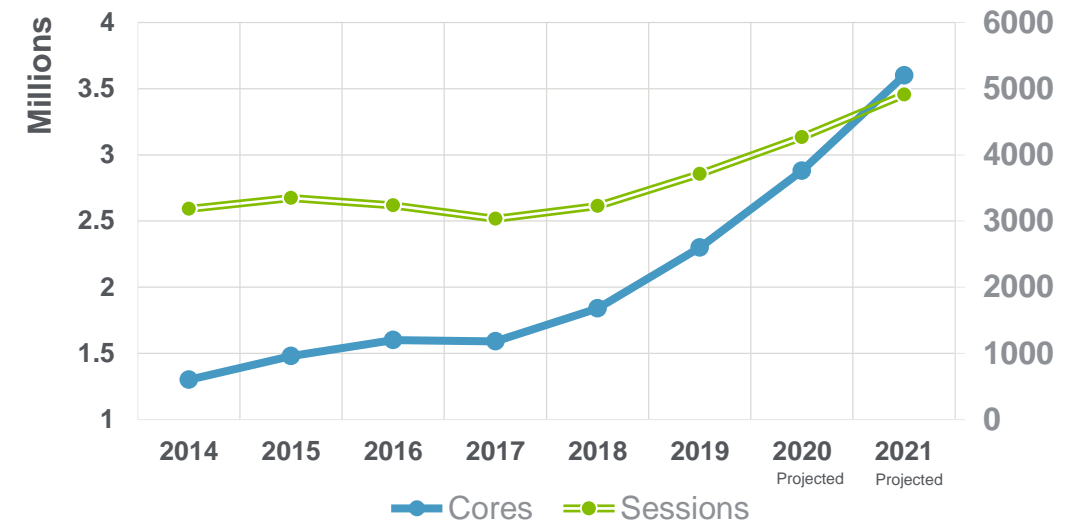


**> 877**  
Physical Blades



**100TB** of  
DRAM

## GPU Cores



**Implemented in 2008 – Award Winning GPU Cloud**

# Big Data in Semiconductor Manufacturing

## Intelligent Control Requires Sensor Knowledge & Analytics



**300mm**  
Single tool

**50KB**  
data per second  
per tool

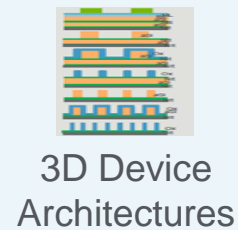
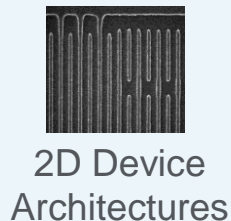
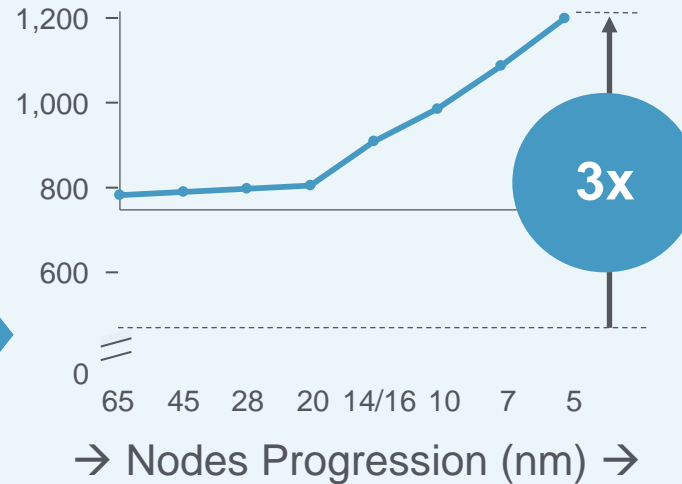
**>500**  
tools per fab\*

**~1PB**  
annual data per fab

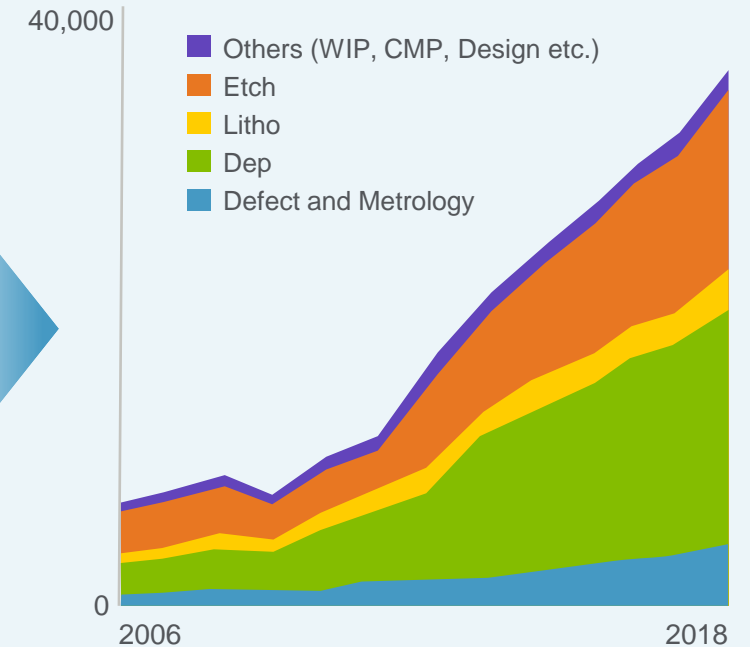
**1,000,000,000,000,000**

\* 30K wspm fab

## No. of Process Steps Grows 3x with Nodes



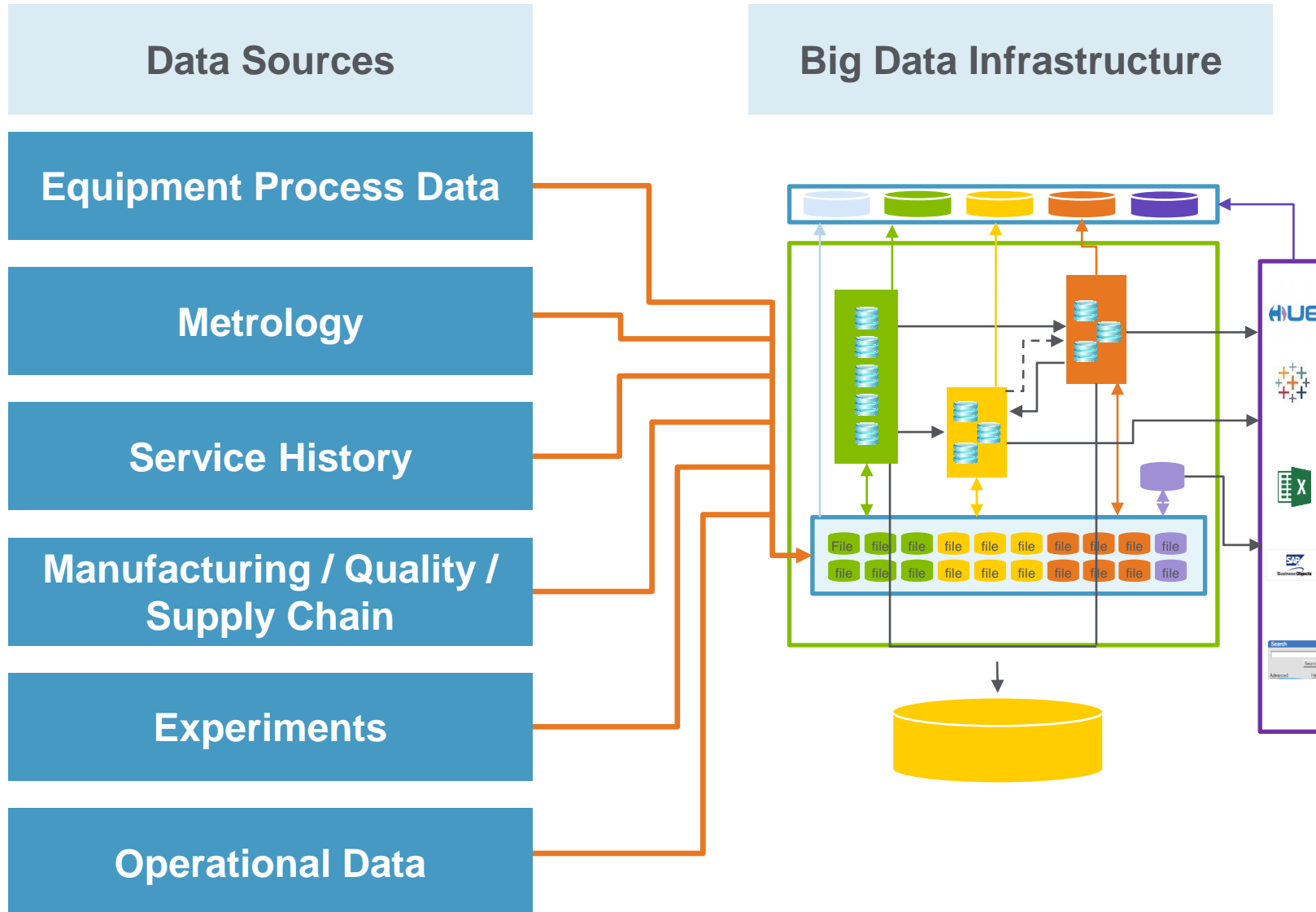
## Quadrillions of Data Points by 2018



Source: VLSI Research & Applied Materials

## How to Make Sense of the Big Data?

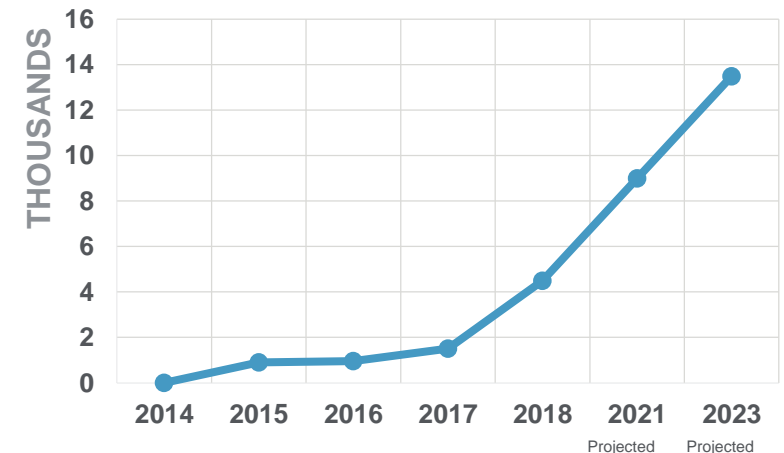
# Applied Big Data Infrastructure



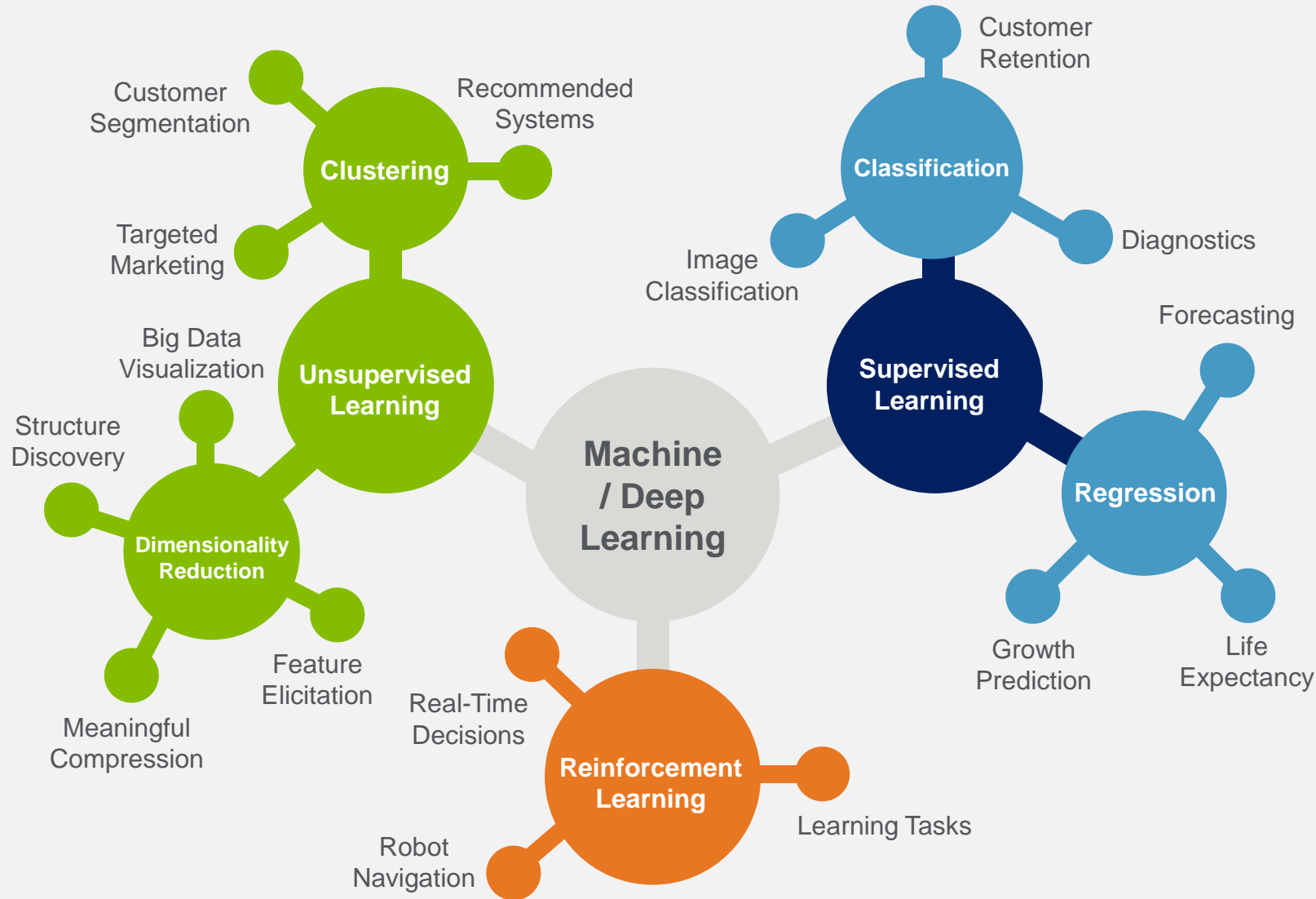
## Technical Data Warehouse (TDW)

- 4.5PB** Storage
- 66TB** Memory
- 5000** Physical Cores
- 7.5TB** Memory

## Big Data Number of Cores



# Machine Learning at Applied



**143K** CUDA Cores

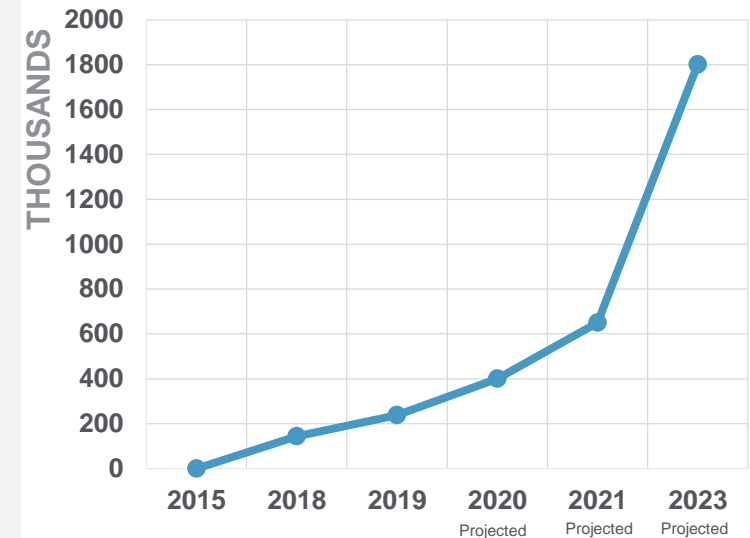


**17.9K** Tensor Cores



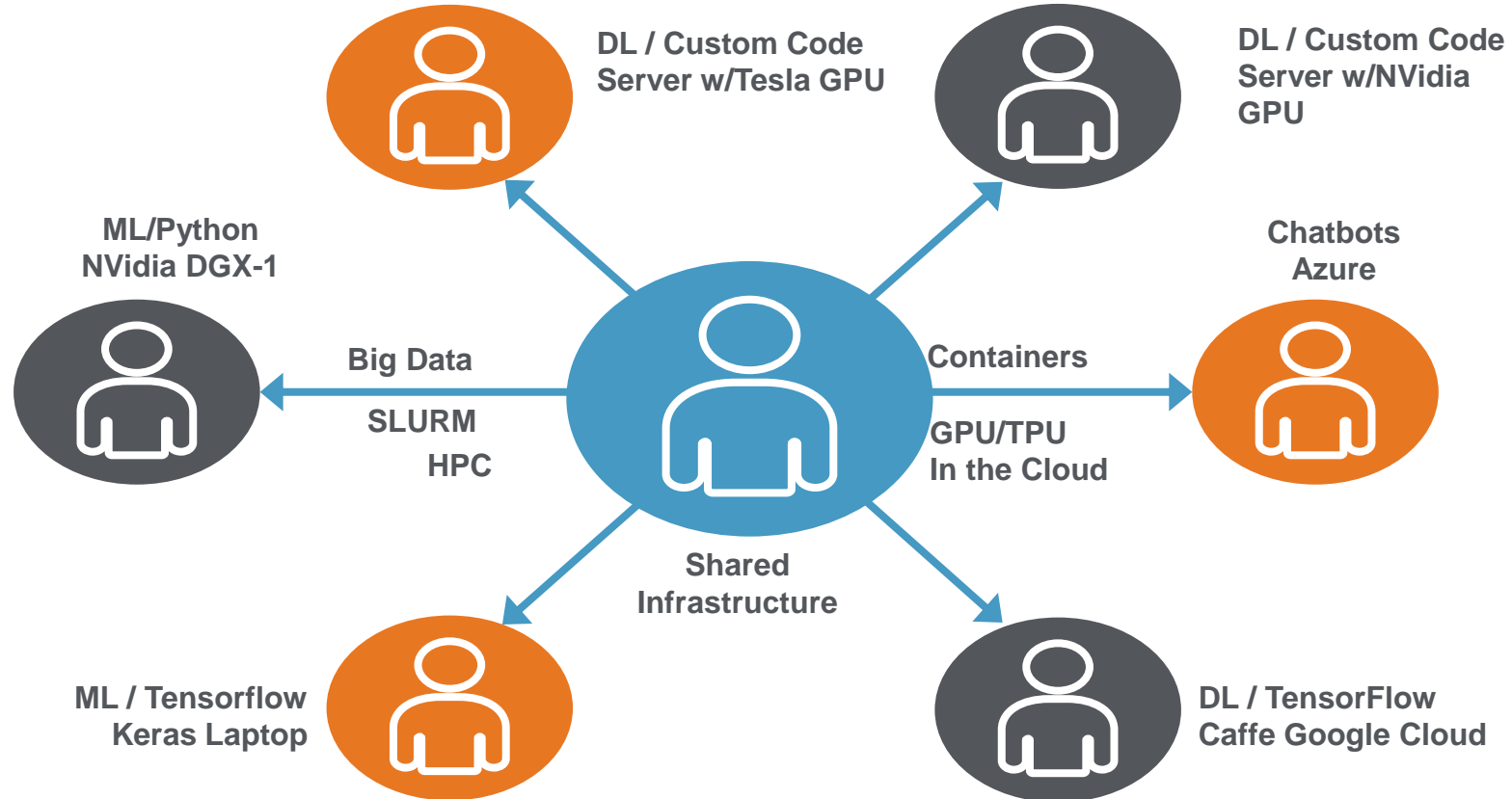
**896GB** Memory

**CUDA Cores**



# Testing, Trials and Options - So Many Options

Complexity in the data center is on the rise



The Use Cases are Many – Still Early

# BREADTH OF CAPABILITY AND PRODUCTS

Materials  
Creation

CVD, PVD, Epi, ALD, Plating

Materials  
Removal

Etch, SRP, CMP, Cleans

Materials  
Modification

Implant, Thermal

Inspection and  
Process Control

Optical, e-Beam



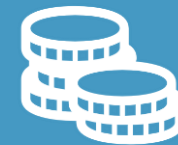
**Connectivity**

*Broad Materials  
Solutions*



**Acceleration**

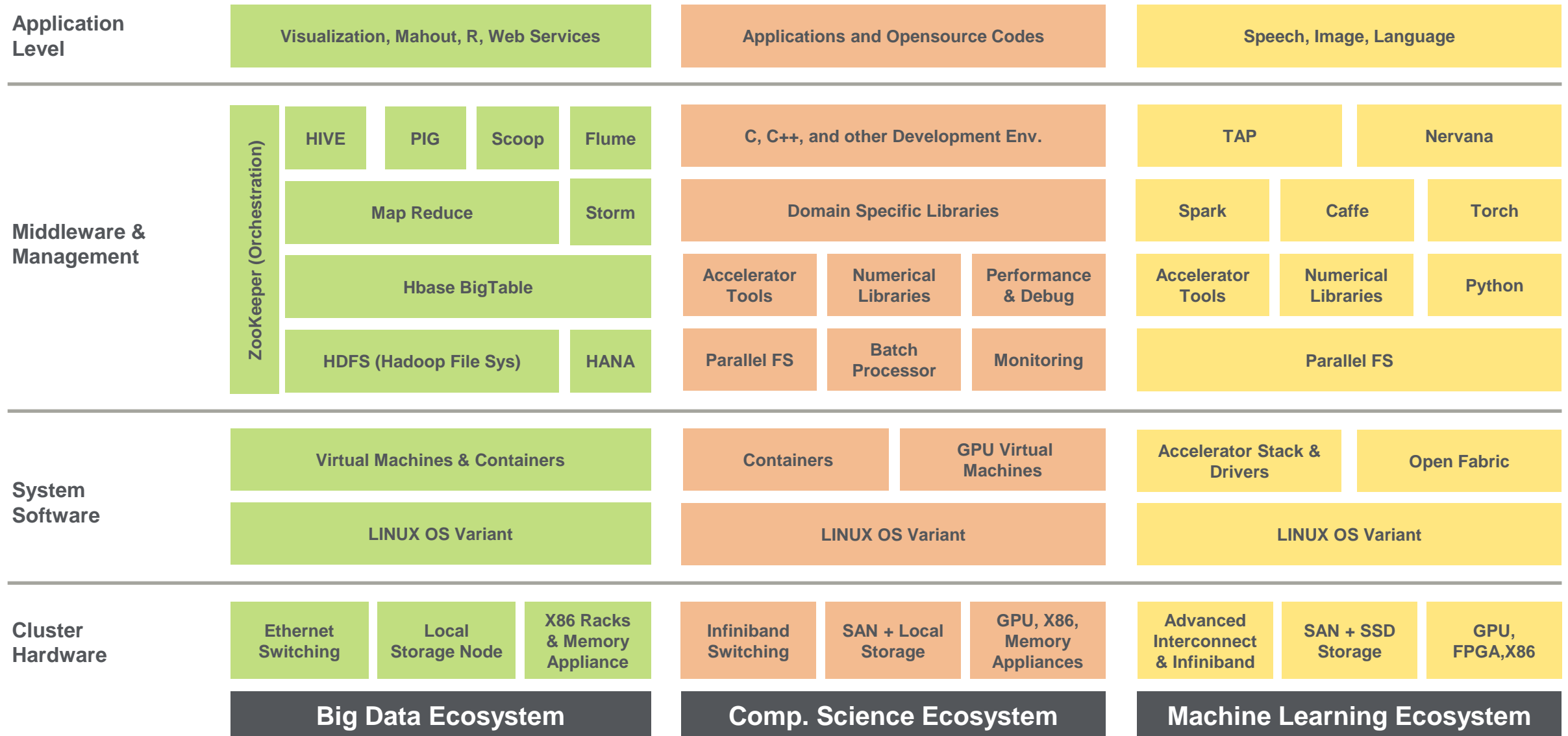
*Computation Process  
Control*



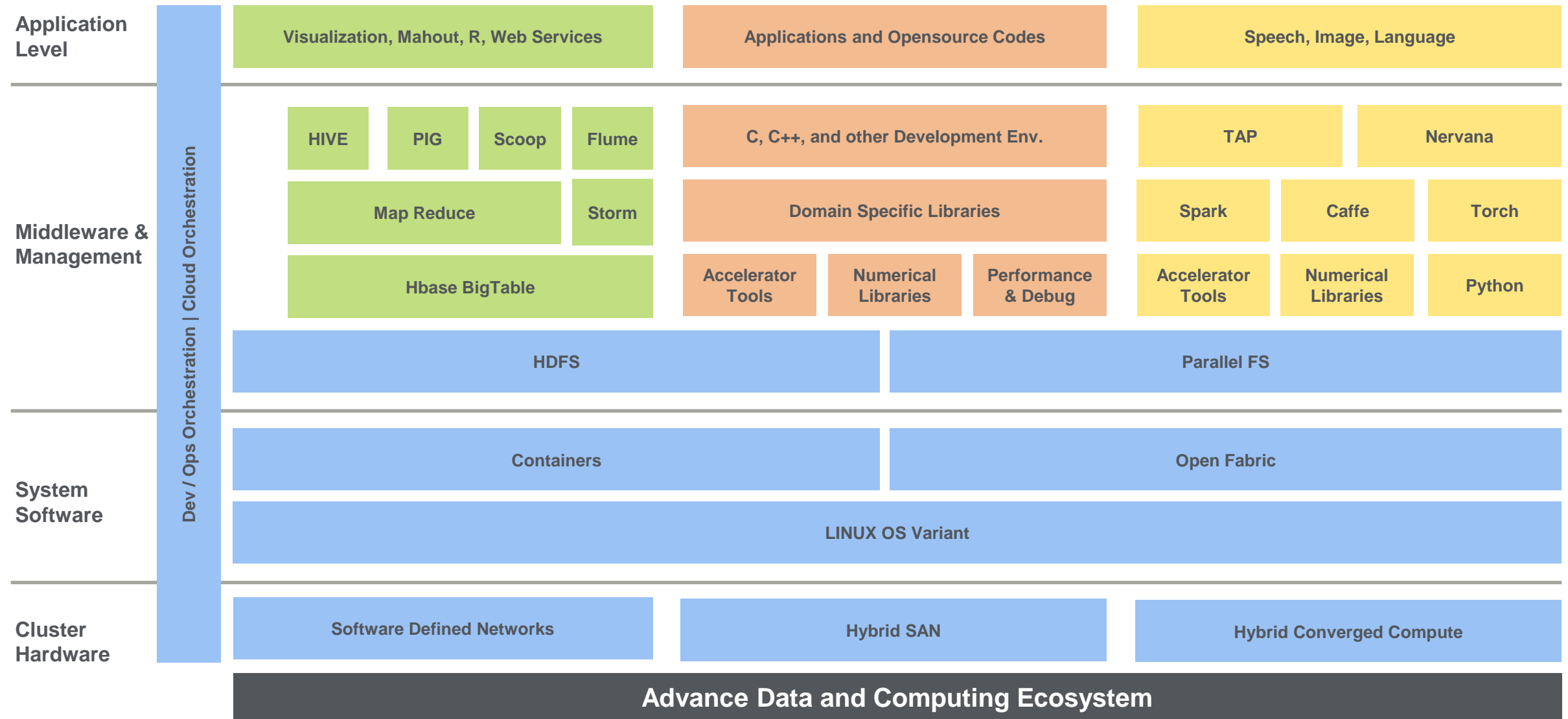
**Valuable**

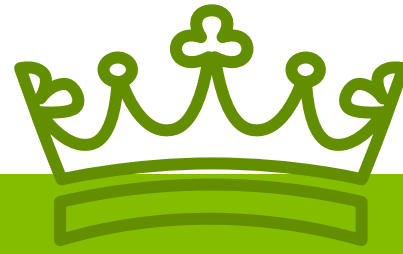
*Customer  
Results*

# A System Level Approach Is Needed – It's Not Easy...



# Convergence is Needed - and so is Heterogenous Computing





## Computational Science (aka HPC)

## Big Data Analytics

## Machine / Deep Learning

Simulation / Physics

3D Visualization

Materials Modeling

High Speed Ingestion & Extraction

Expansive Joins & Enrichment

Expansive Modeling

Supervised

Unsupervised

Reinforcement

